Product Change Notification

TBU™ HIGH SPEED PROTECTORS

Bourns Manufacturers Representatives Corporate Distributor Product Managers Americas Sales Team Asia Sales Team Europe Sales Team



July, 2010

Bourns® TBU™ Products Addition of Second Wafer Fabrication Location

Bourns is adding a second wafer fabrication location, in Korea, for the TBU™ device part numbers below to help assure continued secure supply chain management and delivery support to our customers.

No.	Bourns P/N
1	P650-U180-WH
2	P650-U260-WH
3	P850-U180-WH
4	P850-U260-WH

Reliability data, SGS and MDS reports on the units' package assembly incorporating the above changes will be available on or before August 15, 2010.

Bourns is issuing 90 days notice that mass production from this facility will begin on or about October 31, 2010. There will be no change in form, fit or function and we do not anticipate any impact to our customers' applications.